DECLARATION FOR PATENT APPLICATION AND APPOINTMENT OF ATTORNEY

As a below named inventor, I hereby declare that my residence, post office address and citizenship are as stated below next to my name; I believe that I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention (Design, if applicable) entitled SEMICONDUCTOR PACKAGING STRUCTURE

Is attached hereto

us filed on

T. T.

as Application Serial No.

and (if applicable) was amended on

I hereby state that I have reviewed and understand the contents of the above-identified specification, including the claims, as amended by any amendment(s) referred to above I acknowledge the duty to disclose information which is material to patentability as defined in *Title 37*, *Code of Federal Regulations*, § 1.56. I hereby claim foreign priority benefits under *Title 35*, *United States Code § 119* of any foreign application(s) for patent or inventor's certificate listed below and have also identified below any foreign application for patent or inventor's certificate having a filing date before that of the application on which priority is claimed

PRIOR FOREIGN APPLICATION(S)				PRIORITY CLAIMED	
Number	Country	Day/Month/Year Filed	Yes	No	
<u> </u>				<u> </u>	

I hereby claim the benefit under *Title 35*, *United States Code*, § 120 of any United States application(s) or PCT international application(s) designating The United States of America listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in that/those prior application(s) in the manner provided by the first paragraph of *Title 35*, *United States Code*, § 112, I acknowledge the duty to disclose information which is material to patentability as defined in *Title 37*, *Code of Federal Regulations*, § 1.56 which became available between the filing date of the prior application(s) and the national or PCT international filing date of this application

	Application Number	Filing Date	Status - Patented, Pending or Abandonded
4.			
8 11 5			

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true, and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under section 1001 of title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon

POWER OF ATTORNEY I(We) hereby appoint as my(our) attorneys, with full powers of substitution and revocation, to prosecute with application and transact all business in the Patent and Trademark Office connected therewith

Thomas E. Sisson 29348; Mark H. Miller 29197;

Daniel D. Chapman 32726; William B. Nash 33743

I(We) authorize my(our) attorneys to accept and follow instructions from TAI E INTERNATIONAL PATENT & LAW OFFICE regarding any matter related to the preparation, examination, grant and maintenance of this application, any continuation, continuation-in-part or divisional based thereon, and any patent resulting therefrom, until I(We) or my(our) assigns withdraw this authorization in writing Send correspondence to Jackson Walker L.L.P.

Telephone Calls to (210) 978-7700

112 E. Pecan Street Suite 2100 San Antonio, TX 78205

Attn: Thomas E. Sisson

U.S.A. Full Name of First or Sole Inventor Cheng-Ho HSU Citizenship Taiwan, R.O.C. Post Office Address ■ Same as Residence Residence Address No. 238, Lane 301, Kai-Feng Rd., Hsin-Hsing Dist., Kaohsiung, Taiwan, R.O.C. **SIGNATURE** DATE CHENG-HO HSU October 8, 2001 Full Name of Joint Inventor Yi-Hua CHANG ■ Same as Residence Citizenship Taiwan, R.O.C. Post Office Address Residence Address 6F, No. 10-1, Lane 578, Chung-Lun-Erh Rd., Feng-Shan City, Kaohsiung Hsien, Taiwan, R.O.C. SIGNATURE DATE October 8, 2001

See following pages for additional joint inventors.

DECLARATION FOR PATENT APPLICATION AND APPOINTMENT OF ATTORNEY

Page 2

Full Name of Join Inventor Jen-Cheng LIOU	Ciazonshup Taiwan, R.O.C.
Residence Address No. 59-1, Lane 190, Nan-Tzu-Hsin Rd., Kaohsiung, Taiwan, R.O.C.	Post Office Address 🙊 Sume as Residence
October 8, 2001	SIGNATURE Jeh-Cheng LTOU
Full Name of Joint Inventor	Cinzenship
Residence Address	Post Office Address
EDATE	SIGNATURE
Full Name of Joint Inventor	Citizenshup
Residence Address	Post Office Address
DATE	SIGNATURE
£	
Full Name of Joint Inventor	Citizenship
, Residence Address	Post Office Address Sume as Residence
DATE ÷	SIGNATURE
Full Name of Joint Inventor	Citizenship
Residence Address	Post Office Address Sume as Residence
Date	SIGNATURE
Full Name of Joint Inventor	Сіаг оченр
Residence Address	Post Office Address Sume as Resulence
DATE	SIGNATURE

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of

Inventor(s):Cheng-Ho HSU; Yi-Hua CHANG; Jen-Cheng LIOU

Title:

POWER OF ATTORNEY

Hon. Commissioner of Patents and Trademarks

Washington, D.C. 20231

Sir:

Taiwan IC Packaging Corporation

having become the owner of all rights in and to the aboveidentified application by virtue of an Assignment executed by the inventor(s) concurrently with the execution of the application, said Assignment being submitted herewith for recording, hereby appoints:

Thomas E. Sisson 29348; Mark H. Miller 29197; Daniel D. Chapman 32726; William B. Nash 33743

Whose address is: Jackson Walker L.L.P. 112 E. Pecan Street Suite 2100 San Antonio, TX 78205 U.S.A.

their attorneys to prosecute said application and to transact in connection therewith all business in the Patent and Trademark office and before competent International Authorities.

Date: October 8, 2001

Hsi-Che Teng Legal Representative: Hsi-Che TENG

SMALL BUSINESS

VERIFIED STATEMENT (DECLARATION) CLAIMING SMALL ENTITY STATUS (37 CFR 1.9(f) AND 1.27(c)) - SMALL BUSINESS CONCERN

V910313	•			
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Sign, date [SIGNATURE HSi-Che Teng DATE October 8, 2001			
Insert (NAME Hsi-Che TENG TITLE President ADDRESS 2, South 3rd Rd., K.E.P.Z. Kaohsiung, Taiwan, R.O.C.			
	I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both under section 1001 of Title 18 of the United States Code, and that such willful false statements may jeopardize the validity of the application, any patent issuing thereof, or any patent to which this verified statement is directed.			
	ADDRESS a) () INDIVIDUAL b) () SMALL BUSINESS CONCERN c) () NONPROFIT ORGANIZATION I acknowledge the duty to file, in this application or patent, notification of any change in status resulting in loss of entitlement to small entity status prior to paying, or at the time of paying, the earliest of the issue fee or any maintenance fee due after the date on which status as a small entity is no longer appropriate. (37 CFR 1.28(b))			
insert co-owners, if any, and check a),b) or c) (NAMEADDRESSa) () INDIVIDUAL b) () SMALL BUSINESS CONCERN c) () NONPROFIT ORGANIZATION NAME			
See That the state of the state	If the rights held by the above-identified small business concern are not exclusive, each individual, concern or organization having rights to the invention is listed below and no rights to the invention are held by any person, other than the inventor, who could not qualify as a small business concern under 37 CFR 1.9(d) or by any concern which would not qualify as a small business concern under 37 CFR 1.9(d) or a nonprofit organization under 37 CFR 1.9(e). NOTE: Separate verified statements are required from each named person, concern or organization having rights to the invention averring to their status as small entities. (37 CFR 1.27)			
mames (Check one, Mil in if Di or c)	PACKAGING STRUCTURE by inventor(s) Cheng-Ho HSU: Yi-Hua CHANG; Jen-Cheng LIOU described in a) (X) the specification filed herewith. b) () application serial no, filed c) () patent no, issued			
Insert title of application, inventor's	I hereby declare that rights under contract or law have been conveyed to and remain with the small business concern identified above with regard to the invention, entitled SFMTCONDUCTOR			
	I hereby declare that the above identified small business concern qualifies as a small business concern as defined in 13 CFR 121.3-18, and reproduced in 37 CFR 1.9(d), for purposes of paying reduced fees under section 41(a) and (b) of Title 35, United States Code, in that the number of employees of the concern, including those of its affiliates, does not exceed 500 persons. For purposes of this statement, (1) the number of employees of the business concern is the average over the previous fiscal year of the concern of the persons employed on a full-time, part-time or temporary basis during each of the pay periods of the fiscal year, and (2) concerns are affiliates of each other when either, directly or indirectly, one concern controls or has the power to control the other, or a third party or parties controls or has the power to control both.			
Insert company name and address	identified below: NAME OF CONCERN: Taiwan IC Packaging Corporation ADDRESS OF CONCERN: 2, South 3rd Rd., K.E.P.Z. Kaohsiung, Taiwan, R.O.C.			
Check one [I hereby declare that I am a) (x) the owner of the small business concern identified below: b) () an official of the small business concern empowered to act on behalf of the con			